Switching Diodes Silicon Epitaxial Planar

1SS226

1. Applications

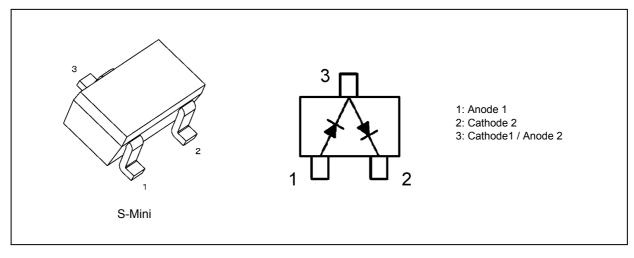
• Ultra-High-Speed Switching

2. Features

(1) AEC-Q101 qualified (Note 1)

Note 1: For detail information, please contact to our sales.

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		85	V
Reverse voltage	V _R		80	
Peak forward current	I _{FM}	(Note 1)	300	mA
Average rectified current	Ι _Ο	(Note 1)	100	
Power dissipation	PD	(Note 2)	150	mW
Non-repetitive peak forward surge current	I _{FSM}	(Note 1), (Note 3)	2	А
Junction temperature	Tj		125	°C
Storage temperature	T _{stg}		-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit rating. Total rating = Unit rating \times 70%

Note 2: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, Pad dimension of 4 mm × 4 mm.

Note 3: Measured with a 10 ms pulse.

5. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F(1)}	I _F = 1 mA	_	0.60	_	V
	V _{F(2)}	I _F = 10 mA	_	0.72	_	
	V _{F(3)}	I _F = 100 mA	—	0.90	1.20	
Reverse current	I _{R(1)}	V _R = 30 V	—	—	0.1	μA
	I _{R(2)}	V _R = 80 V	—		0.5	
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	—	0.9	3.0	pF
Reverse recovery time	t _{rr}	I _F = 10 mA See Fig. 5.1.	—	1.6	4.0	ns

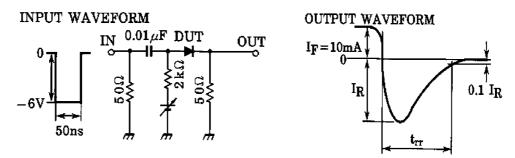
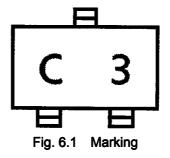
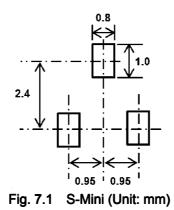


Fig. 5.1 Reverse recovery time (t_{rr}) Test circuit

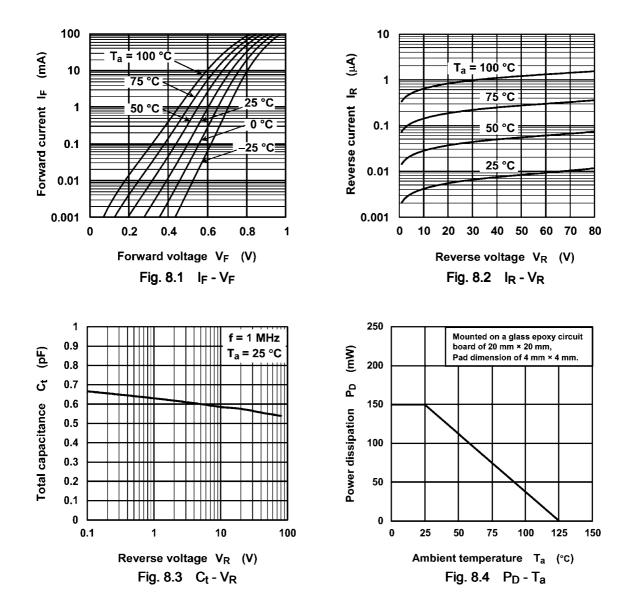
6. Marking



7. Land Pattern Dimensions (for reference only)



8. Characteristics Curves (Note)

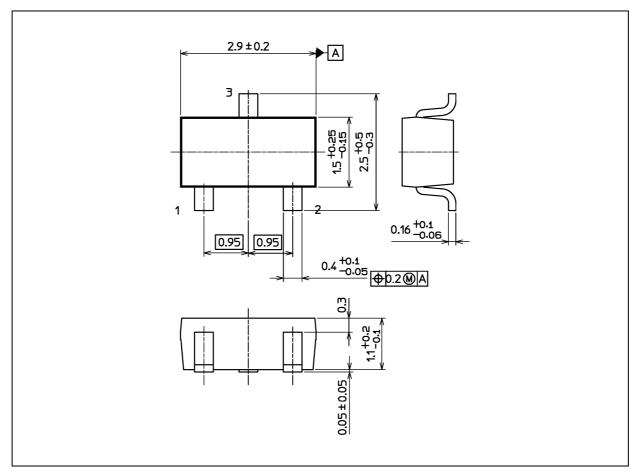


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

1SS226

Package Dimensions

Unit: mm



Weight: 12 mg (typ.)

	Package Name(s)
TOSHIBA: 2-3F1S	
Nickname: S-Mini	

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